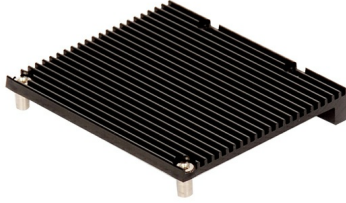


Heatsink

Heatspreader for Qseven Embedded Computer Modules



Intel® Bay Trail Atom™ E3800 series and Celeron® families , Freescale iMX6, AMD Embedded GX Series SOC Processor/platform



Material

Material	Aluminum
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Heatsink

Standard	70(W) x 60(D) x 8(H) mm
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Lite	70(W) x 60(D) x 4(H) mm
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Pro	70(W) x 60(D) x 14(H) mm
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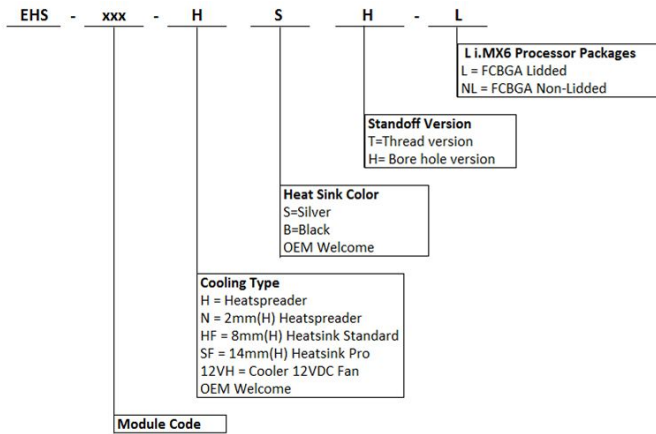
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EFCO
EverFine Group

Note : All product specifications are subject to change without notice

Heatsink



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